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Specification for Approval

Customer:	
Model Name:	

Sı	Customer approval		
R&D Designed	R&D Approved	QC Approved	
Peter	Peng Jun		

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Revision Record

REV NO.	REV DATE	CONTENTS	Note
Α	2024-07-12	NEW ISSUE	
В	2024-07-18	PIN 29 LEDA → NC	
С	2024-07-26	Frame Color:Black	
D	2024-08-05	Revise Pin28 Interface Description	
Е	2024-08-21	Add BLOCK DIAGRAM	
F	2024-08-29	PIN 25 SDO → WRX BL 2 White LEDS→3 White LEDS	
G	2024-09-06	Revise Pin12 \ Pin24 Interface Description	
Н	2024-09-10	Revise the order of Pin 1-36	
I	2024-11-06	Change 2.5±0.2>3.0±0.2	

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1. Scope

This specification defines general provisions as well as inspection standards for TFT module supplied by AMSON electronics.

If the event of unforeseen problem or unspecified items may occur, naturally shall negotiate and agree to solution

2. General Information

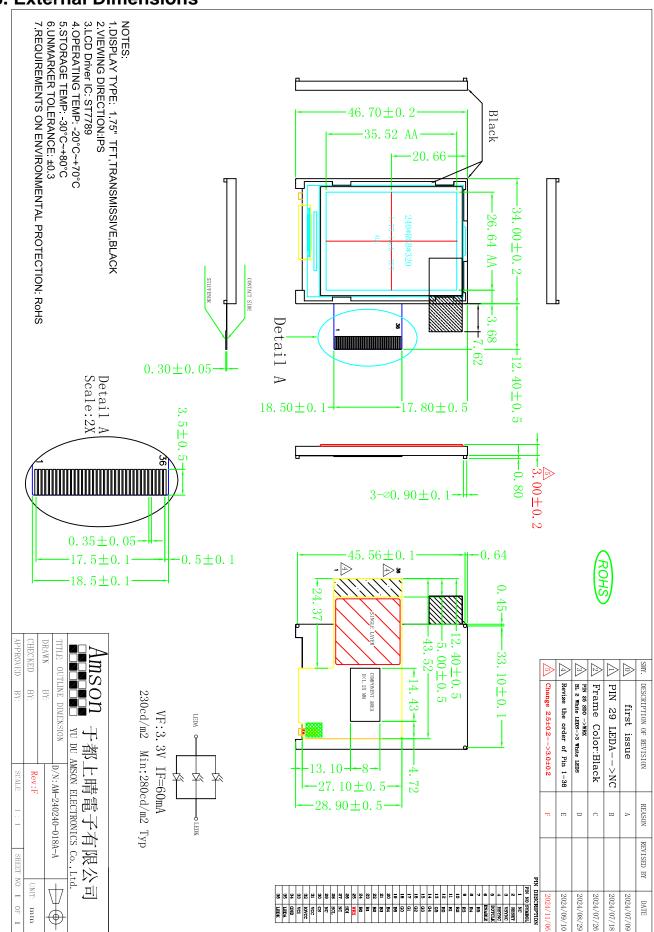
ITEM	STANDARD VALUES	UNITS
LCD type	1.75"TFT	
Dot arrangement	240(RGB)×320	dots
Color filter array	RGB vertical stripe	
Display mode	Transmissive / Normally Black	
Viewing Direction	Free	
Driver IC	ST7789V	
Module size	34.00 (W) * 46.70(H) * 3.0(T)	mm
Active area	26.64 (W) * 35.52 (H)	mm
Dot pitch	0.111 (W) * 0.111 (H)	mm
Interface	4 Line Serial Interface I+16Bit RGB	
Operating temperature	-20 ~ +70	°C
Storage temperature	-30 ~ +80	°C
Back Light	3 White LEDS	
Weight	TBD	g



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3. External Dimensions





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4. Interface Description

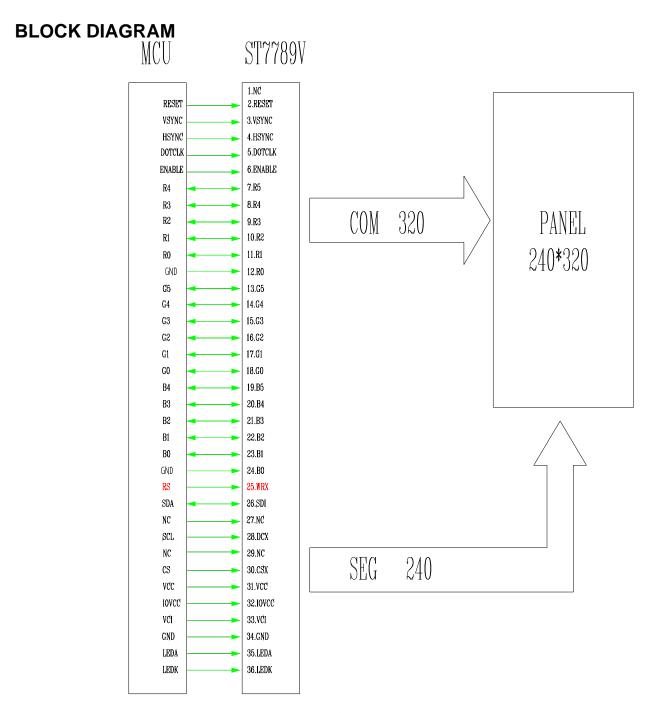
Pin	Symbol	I/O	Function
1	NC		No Connect
2	RESX	I	Reset pin , Signal is active low.
3	VSYNC	I	Frame Synchronizing Signal
4	HSYNC	I	Linc Synchronizing Signal
5	DOTLCK	I	Dot clock signal for RGB interface operation.
6	ENABLE	I	Data Enable
7	R5	I/O	Data Bus
8	R4	1/0	Data Bus
9	R3	I/O	Data Bus
10	R2	I/O	Data Bus
11	R1	I/O	Data Bus
12	R0	I/O	Please fix this pin at GND (16Bit RGB)
13	G5	1/0	Data Bus
14	G4	1/0	Data Bus
15	G3	I/O	Data Bus
16	G2	1/0	Data Bus
17	G1	1/0	Data Bus
18	G0	1/0	Data Bus
19	B5	I/O	Data Bus
20	B4	I/O	Data Bus
21	В3	1/0	Data Bus
22	B2	I/O	Data Bus
23	B1	I/O	Data Bus
24	В0		Please fix this pin at GND (16Bit RGB)
25	WRX		Display data / command selection
26	SDA	I/O	Serial Instruction Data Input/output
27	NC		No Connect
28	DCX	I	Serial Clock
29	NC		No Connect
30	CSX	I	Chip Selection Signal
31	VCC	Р	Power Supply For Logic



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32	IOVCC	Р	Power Supply For Interface Signal
33	VCI	Р	Power Supply For Analog
34	GND		Ground
35	LED_A	Р	Anode for LED backlighting
36	LED_K	Р	Cathode for LED backlighting



4-line serial interface 1+16BIT RGB



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5. Absolute Maximum Ratings

Item	Symbol	Min.	Max.	Unit
	IOVCC	-0.3	4.6	V
Logic Supply Voltage	VCC	-0.3	4.6	V
	VCI	-0.3	4.6	V
Input Voltage	Vin	-0.3	IOVCC+0.3	V
Operating Temperature	Тор	-20	70	°C
Storage Temperature	Тѕт	-30	80	°C
Storage Humidity	HD	20	90	%RH

6. DC Characteristics

Item	Symbol	Min.	Тур.	Max.	Unit	Remark
	IOVCC	2.5	2.8	3.3	٧	-
Logic Supply Voltage	VCC	2.5	2.8	3.3	٧	-
	VCI	2.5	2.8	3.3	٧	
Input High Voltage	V _{IH}	0.8IOVCC		IOVCC	٧	Digital input pins
Input Low Voltage	V _{IL}	VSS		0.2IOVCC	٧	Digital input pins
Output High Voltage	V _{OH}	0.8IOVCC		IOVCC	٧	Digital output pins
Output Low Voltage	V _{OL}	VSS		0.2IOVCC	V	Digital output pins
I/O Leak Current	ILI	-0.1		0.1	uA	

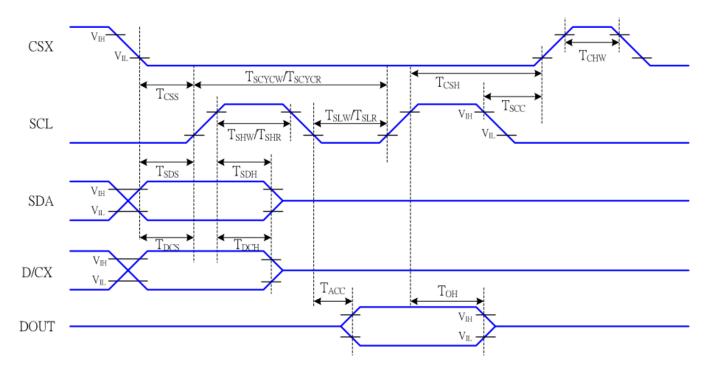
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7. Timing Characteristics

7.1 Serial Data Transfer Interface Timing Characteristics

Signal	Symbol	Parameter	MIN	MAX	Unit	Description
	T _{CSS}	Chip select setup time (write)	15		ns	
[T _{CSH}	Chip select hold time (write)	15		ns	
CSX	T _{CSS}	Chip select setup time (read)	60		ns	
	T _{scc}	Chip select hold time (read)	65		ns	
	T _{CHW}	Chip select "H" pulse width	40		ns	
	T _{SCYCW}	Serial clock cycle (Write)	66		ns	-write command & data
	T _{SHW}	SCL "H" pulse width (Write)	15		ns	ram
SCL	T _{SLW}	SCL "L" pulse width (Write)	15		ns	Taili
SOL	T _{SCYCR}	Serial clock cycle (Read)	150		ns	-read command & data
	T _{SHR}	SCL "H" pulse width (Read)	60		ns	ram
	T _{SLR}	SCL "L" pulse width (Read)	60		ns	Taili
D/CX	T _{DCS}	D/CX setup time	10		ns	
DICX	T _{DCH}	D/CX hold time	10		ns	
SDA	T _{SDS}	Data setup time	10		ns	
(DIN)	T _{SDH}	Data hold time	10		ns	
DOUT	T _{ACC}	Access time	10	50	ns	For maximum CL=30pF
D001	Тон	Output disable time	15	50	ns	For minimum CL=8pF

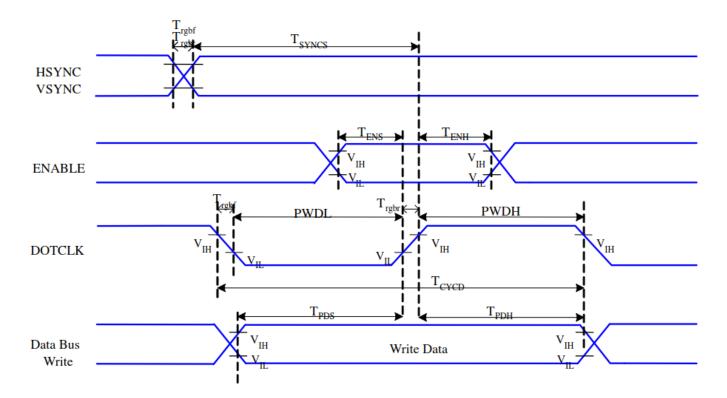


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7.2 RGB Interface Timing Characteristics

Signal	Symbol	Parameter	MIN	MAX	Unit	Description
HSYNC,	т	VSYNC, HSYNC Setup Time	30		ns	
VSYNC	T _{SYNCS}	vorno, no mo setup nine	30	_	115	
ENABLE	T _{ENS}	Enable Setup Time	25	-	ns	
T _{ENH}	T _{ENH}	Enable Hold Time	25	-	ns	
	PWDH	DOTCLK High-level Pulse Width	60	-	ns	
DOTCLK	PWDL	DOTCLK Low-level Pulse Width	60	-	ns	
DOTCLK	T _{CYCD}	DOTCLK Cycle Time	120	-	ns	
	Trghr, Trghf	DOTCLK Rise/Fall time	-	20	ns	
DB	T _{PDS}	PD Data Setup Time	50	-	ns	
DB	T _{PDH}	PD Data Hold Time	50	-	ns	

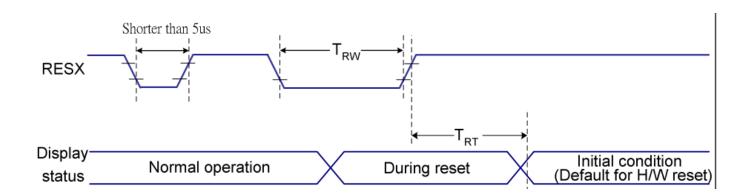


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7.3 Reset Timing Characteristics

Related Pins	Symbol	Parameter	MIN	MAX	Unit
RESX	TRW	Reset pulse duration	10	-	us
	TRT	Reset cancel	-	5 (Note 1, 5)	ms
		neset cancer		120 (Note 1, 6, 7)	ms

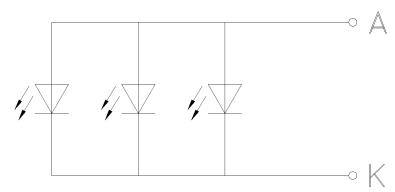




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8. Backlight Characteristic



Item	Symbol	MIN	TYP	MAX	UNIT	Test Condition
Supply Voltage	Vf	2.8		3.2	V	If=60mA
Supply Current	lf		60		mA	
Luminous Intensity for LCM		230	280		cd/m ²	If=60mA
Backlight Color	White					



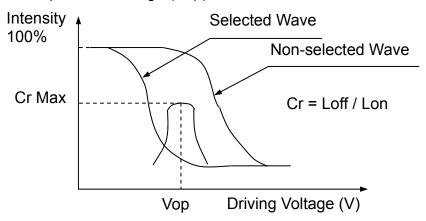
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9. Optical Characteristics

Item	Conditions		Min.	Тур.	Max.	Unit	Note	
	Horizontal	θL	-	80	-	degree		
Viewing Angle		θR	-	80	-		(1),(2),(6)	
(CR>10)	\/o=t:==1	θт	-	80	-			
	Vertical	θв	-	80				
Contrast Ratio	Center		200	300	-	-	(1),(3),(6)	
Response Time	$T_{R+}T_{F}$			20	40	ms	(1),(4),(6)	
	Red x			0.599	+/-0.02		(1) (6)	
	Red y			0.362				
	Green x			0.344				
CF Color	Green y		+/-0.02	0.599				
Chromaticity (CIE1931)	Blue x		+/-0.02	0.160	50		(1), (6)	
,	Blue y			0.118]			
	White x			0.320				
	White y			0.364				
Color Gamut	CIE1931		54	60	-	%	(1),(6)	

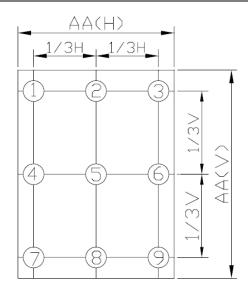
Note1:Definition of Operation Voltage (Vop)



Note2: Definition of Luminance Uniformity: L = L(MIN) / L (MAX) × 100%

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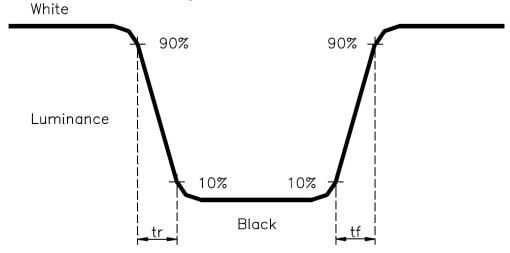
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Note 3. Definition of Contrast Ratio

CR = White Luminance (ON) / Black Luminance (OFF)

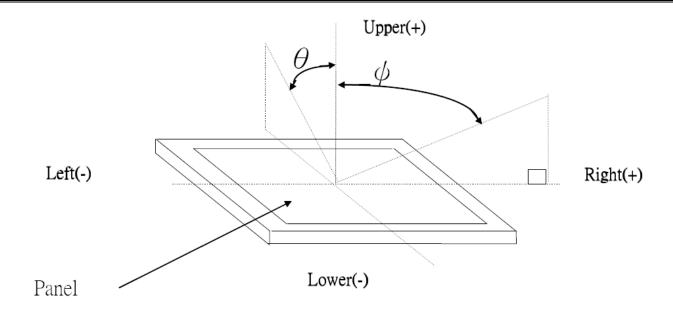
Note 4. Definition of response time: The response time is defined as the time interval between the 10% and 90% amplitudes.



Note 5. Definition of view angle(θ , ψ):

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Note 6. Definition of color chromaticity (CIE1931)

Color coordinates measured at the center point of LCD.



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10. Reliability Test Conditions and Methods

NO.	ITEM	CONDITION	CRITERION
1	High Temperature Operating	60°C 240 hrs	No Defect OfOperational Function In
2	Low Temperature Operating		Room Temperature Are Allowable.
3	High Temperature Non-Operating	70°C 240 hrs	∘ Leakage current should
4	Low Temperature Non-Operating	-20°C 240 hrs	be below double of initial value.
5	High Temperature/ Humidity Non-Operating	60°C ,90%RH 240 hrs	
6	Temperature Shock Non-Operating	-20°C 70°C (30min) (5min) (30min) 100 CYCLES	
7	Electrostatic Discharge Test Non-Operating	HBM:±2kV	

Note 1: Test after 24 hours in room temperature.

Note 2: The sampling above is individually for each reliability testing condition.

Note 3: The color fading of polarizing filter should not care.

Note 4: All of the reliability testing chamber above, is using D.I. water.(Min value: 1.0 MΩ-cm)

Note 5: In case of malfunction defect caused by ESD damage, if it would be recovered to normal state after resetting, it would be judged as a good part.



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11. Inspection Standard

11.1. QUALITY:

THE QUALITY OF GOODS SUPPLIED TO PURCHASER SHALL COME UP TO THE FOLLOWING STANDARD.

11.1.1. THE METHOD OF PRESERVING GOODS

AFTER DELIVERY OF GOODS FROM AMSON TO PURCHASER. PURCHASER SHALL CONTROL THE LCM AT -10 $^{\circ}$ C TO 40 $^{\circ}$ C ,AND IT MIGHT BE DESIRABLE TO KEEP AT THE NORMAL ROOM TEMPERATURE AND HUMIDITY UNTIL INCOMING INSPECTION OR THROWING INTO PROCESS LINE.

11.1.2. INCOMING INSPECTION

(A) THE METHOD OF INSPECTION

IF PURCHASER MAKE AN INCOMING INSPECTION, A SAMPLING PLAN SHALL BE APPLIED ON THE CONDITION THAT QUALITY OF ONE DELIVERY SHALL BE REGARDED AS ONE LOT.

(B) THE STANDARD OF QUALITY

ISO-2859-1 (SAME AS MIL-STD-105E), LEVEL II SINGLE PLAN.

CLASS	AQL(%)
CRITICAL	0.4 %
MAJOR	0.65 %
MINOR	1.5 %
TOTAL	1.5 %

EVERY ITEM SHALL BE INSPECTED ACCORDING TO THE CLASS.

(C) MEASURE

IF AS THE RESULT OF ABOVE RECEIVING INSPECTION, A LOT OUT IS DISCOVERED. PURCHASER SHALL BE INFORM SELLER OF IT WITHIN SEVEN DAYS. BUT FIRST SHIPMENT WITHIN FOURTEEN DAYS.

11.1.3. WARRANTY POLICY

AMSON WILL PROVIDE ONE-YEAR WARRANTY FOR THE PRODUCTS ONLY IF UNDER SPECIFICATION OPERATING CONDITIONS. AMSON WILL REPLACE NEW PRODUCTS FOR THESE DEFECT PRODUCTS WHICH UNDER WARRANTY PERIOD AND BELONG TO THE RESPONSIBILITY OF AMSON.

11.2. CHECKING CONDITION

- 11.2.1. CHECKING DIRECTION SHALL BE IN THE 45 DEGREE AREA TO FACE THE SAMPLE.
- 11.2.2. CHECKER SHALL SEE OVER 300±25 mm. WITH BARE EYES FAR FROM SAMPLE AND USING 2 PCS. OF 20W FLUORESCENT LAMP.



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11.3. INSPECTION PLAN:

11.0. INOT EO	TION PLAN.	,	
CLASS	ITEM	JUDGEMENT	CLASS
	1. OUTSIDE AND INSIDE PACKAGE	"MODEL NO." , "LOT NO." AND "QUANTITY"	Minor
PACKING &		SHOULD INDICATE ON THE PACKAGE.	
INDICATE	2. MODEL MIXED AND QUANTITY	OTHER MODEL MIXEDREJECTED	Critical
		QUANTITY SHORT OR OVERREJECTED	
	3. PRODUCT INDICATION	"MODEL NO." SHOULD INDICATE ON	Major
		THE PRODUCT	,
	4. DIMENSION,	ACCORDING TO SPECIFICATION OR	
ASSEMBLY	LCD GLASS SCRATCH	DRAWING.	Major
	AND SCRIBE DEFECT.		j
	5. VIEWING AREA	POLARIZER EDGE OR LCD'S SEALING LINE	Minor
		IS VISABLE IN THE VIEWING AREA	
		REJECTED	
	6. BLEMISH - BLACK SPOT -	ACCORDING TO STANDARD OF VISUAL	Minor
	WHITE SPOT IN THE LCD	INSPECTION(INSIDE VIEWING AREA)	
	AND LCD GLASS CRACKS	, , , , , , , , , , , , , , , , , , ,	
	7. BLEMISH - BLACK SPOT	ACCORDING TO STANDARD OF VISUAL	Minor
APPEARANCE	WHITE SPOT AND SCRATCH	INSPECTION(INSIDE VIEWING AREA)	
	ON THE POLARIZER	,	
	8. BUBBLE IN POLARIZER	ACCORDING TO STANDARD OF VISUAL	Minor
		INSPECTION(INSIDE VIEWING AREA)	
	9. LCD'S RAINBOW COLOR	STRONG DEVIATION COLOR (OR NEWTON	
		RING) OF LCDREJECTED.	Minor
		OR ACCORDING TO LIMITED SAMPLE	
		(IF NEEDED, AND INSIDE VIEWING AREA)	
	10. ELECTRICAL AND OPTICAL	ACCORDING TO SPECIFICATION OR	Critical
	CHARACTERISTICS	DRAWING . (INSIDE VIEWING AREA)	
	(CONTRAST. VOP.		
	CHROMATICITY ETC)		
ELECTRICAL	11.MISSING LINE	MISSING DOT. LINE . CHARACTER	Critical
		REJECTED	
	12.SHORT CIRCUIT	NO DISPLAY · WRONG PATTERN	Critical
	WRONG PATTERN DISPLAY	DISPLAY • CURRENT CONSUMPTION	
		OUT OF SPECIFICATION REJECTED	
	13. DOT DEFECT (FOR COLOR AND TFT)	ACCORDING TO STANDARD OF VISUAL	Minor
		INSPECTION	



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11.4. STANDARD OF VISUAL INSPECTION

NO.	CLASS	ITEM	JUDGEMENT				
140.	027,000	11 - 191	(A) ROUND TYPE: unit : mm.				
			DIAMETER (mm.) ACCEPTABLE Q'TY				
			$\Phi \leq 0.1$ DISREGARD				
			$0.1 < \Phi$ ≤ 0.25 3 (Distance>5mm)				
		BLACK AND WHITE SPOT	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$				
		FOREIGN MATERIEL	NOTE: Φ =(LENGTH+WIDTH)/2				
11.4.1	MINOR	DUST IN THE CELL BLEMISH	(B) LINEAR TYPE: unit : mm.				
		SCRATCH	LENGTH WIDTH ACCEPTABLE Q'TY				
		CONATON	W ≤0.03 DISREGARD				
			$L \le 5.0$ 0.03 < W ≤ 0.07 3 (Distance>5mm)				
			0.07 < W FOLLOW ROUND TYPE				
			unit : mm.				
			DIAMETER ACCEPTABLE Q'TY				
l	MINIOD	BUBBLE IN POLARIZER DENT ON POLARIZER	$\Phi \leq 0.2 \text{DISREGARD}$				
11.4.2	MINOR		$0.2 < \Phi \leq 0.5$ 2 (Distance>5mm)				
			<u>0.5 < Ф</u> 0				
		Dot Defect	Items ACC. Q'TY				
			Bright dot N≤ 4 (Distance>5mm)				
			Dark dot N≤ 4 (Distance>5mm)				
			Pixel Define : Pixel —				
	MINIOD		R G B				
11.4.3	MINOR		◆ Dot → ◆ Dot →				
			Note 1: The definition of dot: The size of a defective dot over				
			1/2 of whole dot is regarded as one defective dot. Note 2: Bright dot: Dots appear bright and unchanged in size				
			in which LCD panel is displaying under black pattern.				
			Note 3: Dark dot: Dots appear dark and unchanged in size in				
			which LCD panel is displaying under pure red, green				
			,blue pattern.				
			-				



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NO.	CLASS	ITEM	JUDGEMEN	Т
11.4.4	MINOR	LCD GLASS CHIPPING	Š V	Y > S Reject
11.4.5	MINOR	LCD GLASS CHIPPING	SY	X or Y > S Reject
11.4.6	MAJOR	LCD GLASS GLASS CRACK	T	Y > (1/2) T Reject
11.4.7	MAJOR	LCD GLASS SCRIBE DEFECT	$A_{\uparrow}^{\perp} = A_{\uparrow}$	 a> L/3 , A>1.5mm. Reject B: ACCORDING TO DIMENSION
11.4.8	MINOR	LCD GLASS CHIPPING (ON THE TERMINAL AREA)	T	$\Phi = (x+y)/2 > 2.5 \text{ mm}$ Reject
11.4.9	MINOR	LCD GLASS CHIPPING (ON THE TERMINAL SURFACE)	TZX	Y > (1/3) T Reject
11.4.10	MINOR	LCD GLASS CHIPPING	T Z	Y > T Reject



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12. Handling Precautions

12.1 Mounting method

The LCD panel of AMSON TFT module consists of two thin glass plates with polarizes which easily be damaged. And since the module in so constructed as to be fixed by utilizing fitting holes in the printed circuit board.

Extreme care should be needed when handling the LCD modules.

12.2 Caution of LCD handling and cleaning

When cleaning the display surface, Use soft cloth with solvent

[Recommended below] and wipe lightly

- Isopropyl alcohol
- Ethyl alcohol

Do not wipe the display surface with dry or hard materials that will damage the polarizer surface.

Do not use the following solvent:

- Water
- Aromatics

Do not wipe ITO pad area with the dry or hard materials that will damage the ITO patterns Do not use the following solvent on the pad or prevent it from being contaminated:

- Soldering flux
- Chlorine (CI), Sulfur (S)

If goods were sent without being sili8con coated on the pad, ITO patterns could be damaged due to the corrosion as time goes on.

If ITO corrosion happen by miss-handling or using some materials such as Chlorine (CI), Sulfur (S) from customer, Responsibility is on customer.

12.3 Caution against static charge

The LCD module use C-MOS LSI drivers, so we recommended that you:

Connect any unused input terminal to POWER or GROUND, do not input any signals before power is turned on, and ground your body, work/assembly areas, and assembly equipment to protect against static electricity.

12.4 packing

- Module employs LCD elements and must be treated as such.
- Avoid intense shock and falls from a height.
- To prevent modules from degradation, do not operate or store them exposed direct to sunshine or high temperature/humidity

12.5 Caution for operation

- It is an indispensable condition to drive LCD's within the specified voltage limit since the higher voltage then the limit cause the shorter LCD life.
- An electrochemical reaction due to direct current causes LCD's undesirable deterioration, so that the use of direct current drive should be avoided.
- Response time will be extremely delayed at lower temperature then the operating temperature range and on the other hand at higher temperature LCD's how dark color in them. However those phenomena do not mean malfunction or out of order with LCD's, which will come back in the specified operation temperature.
- If the display area is pushed hard during operation, some font will be abnormally displayed but it resumes normal condition after turning off once.
- Slight dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal open circuit.
 - Usage under the maximum operating temperature, 50%Rh or less is required.



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12.6 storing

In the case of storing for a long period of time for instance, for years for the purpose or replacement use, the following ways are recommended.

- Storage in a polyethylene bag with the opening sealed so as not to enter fresh air outside in it. And with no desiccant.
- Placing in a dark place where neither exposure to direct sunlight nor light's keeping the storage temperature range.
- Storing with no touch on polarizer surface by the anything else.
 [It is recommended to store them as they have been contained in the inner container at the time of delivery from us

12.7 Safety

- It is recommendable to crash damaged or unnecessary LCD's into pieces and wash off liquid crystal by either of solvents such as acetone and ethanol, which should be burned up later.
- When any liquid leaked out of a damaged glass cell comes in contact with your hands, please wash it off well with soap and water

13. Precaution for Use

13.1

A limit sample should be provided by the both parties on an occasion when the both parties agreed its necessity. Judgment by a limit sample shall take effect after the limit sample has been established and confirmed by the both parties.

13.2

On the following occasions, the handing of problem should be decided through discussion and agreement between responsible of the both parties.

- When a question is arisen in this specification
- When a new problem is arisen which is not specified in this specifications
- When an inspection specifications change or operating condition change in customer is reported to AMSON TFT, and some problem is arisen in this specification due to the change
- When a new problem is arisen at the customer's operating set for sample evaluation in the customer site.

14. Packing Method